

Claims

1. A structure of pseudomorphic High Electron Mobility Transistor (pHEMT), which comprises a semiconductor substrate, a buffer layer on said semiconductor substrate, a non-doped strain layer on said buffer layer, a first non-doped spacer layer on said non-doped strain layer, a δ -doped carrier supplying layer on said first non-doped spacer layer, a second non-doped spacer layer on said δ -doped carrier supplying layer, a n-doped semiconductor layer on said second non-doped spacer layer, a p^+ -doped semiconductor layer on said n-doped semiconductor layer, and a n^+ -doped semiconductor covering layer over the aforementioned p^+ -doped semiconductor layer. In the structure of the presented pHEMT, the first non-doped spacer layer, the second non-doped spacer layer, the n-doped semiconductor layer, and the p^+ -doped semiconductor layer are made of the same material.
2. The structure as defined in claim 1 further comprising an additional δ -doped carrier supplying layer on said buffer layer, an additional non-doped spacer layer on said additional δ -doped carrier supplying layer, wherein said non-doped strain layer is on said additional non-doped spacer layer.
3. The structure as defined in claims 1 or 2, wherein said semiconductor substrate is a semi-insulating GaAs.
4. The structure as defined in claims 1 or 2, wherein said buffer layer inside is a non-doped GaAs.
5. The structure as defined in claim 1 or 2, wherein said non-doped strain layer is a $\text{In}_x\text{Ga}_{1-x}\text{As}$, wherein x is $0.05 \sim 0.25$, and has a thickness ranging from 50 \AA to 200 \AA .
6. The structure as defined in claim 1 or 2, wherein said first non-doped spacer layer and said second non-doped spacer layer are $\text{In}_{0.49}\text{Ga}_{0.51}\text{P}$, and have a thickness ranging from 25 \AA to 100 \AA .
7. The structure as defined in claim 1 or 2, wherein said first non-doped spacer layer and said second non-doped spacer layer are $\text{Al}_x\text{Ga}_{1-x}\text{As}$, wherein x is $0.2 \sim 0.5$, and have a thickness ranging from 25 \AA to 100 \AA .

8. The structure as defined in claim 1 or 2, wherein said δ -doped carrier supplying has a concentration of $\delta(n) = 1 \times 10^{12} \sim 1 \times 10^{13} \text{ cm}^{-3}$.
9. The structure as defined in claim 2, wherein said additional δ -doped carrier supplying layer has a concentration of $\delta(n) = 1 \times 10^{12} \sim 1 \times 10^{13} \text{ cm}^{-3}$.
- 5 10. The structure as defined in claim 2, wherein said additional non-doped spacer layer is GaAs, and has a thickness ranging from 25 \AA to 100 \AA .
11. The structure as defined in claim 1 or 2, wherein said n-doped semiconductor layer is $\text{In}_{0.49}\text{Ga}_{0.51}\text{P}$, and has a thickness ranging from 200 \AA to 1000 \AA and a concentration of $n = 5 \times 10^{16} \sim 5 \times 10^{17} \text{ cm}^{-3}$.
- 10 12. The structure as defined in claim 1 or 2, wherein said n-doped semiconductor layer is $\text{Al}_x\text{Ga}_{1-x}\text{As}$, wherein x is $0.2 \sim 0.5$, and has a thickness ranging from 200 \AA to 1000 \AA and a concentration of $n = 5 \times 10^{16} \sim 5 \times 10^{17} \text{ cm}^{-3}$.
13. The structure as defined in claim 1 or 2, wherein said p^+ -doped semiconductor layer is $\text{In}_{0.49}\text{Ga}_{0.51}\text{P}$, and has a thickness ranging from 80 \AA to 200 \AA and a concentration of $p^+ = 1 \times 10^{18} \sim 4 \times 10^{19} \text{ cm}^{-3}$.
- 15 14. The structure as defined in claim 1 or 2, wherein said p^+ -doped semiconductor layer is $\text{Al}_x\text{Ga}_{1-x}\text{As}$, wherein x is $0.2 \sim 0.5$, and has a thickness ranging from 80 \AA to 200 \AA and a concentration of $p^+ = 1 \times 10^{18} \sim 4 \times 10^{19} \text{ cm}^{-3}$.
- 20 15. The structure as defined in claim 1 or 2, wherein said n^+ -doped semiconductor covering layer is GaAs, and has a thickness ranging from 150 \AA to 400 \AA and a concentration of $n^+ = 1 \times 10^{18} \sim 4 \times 10^{19} \text{ cm}^{-3}$.